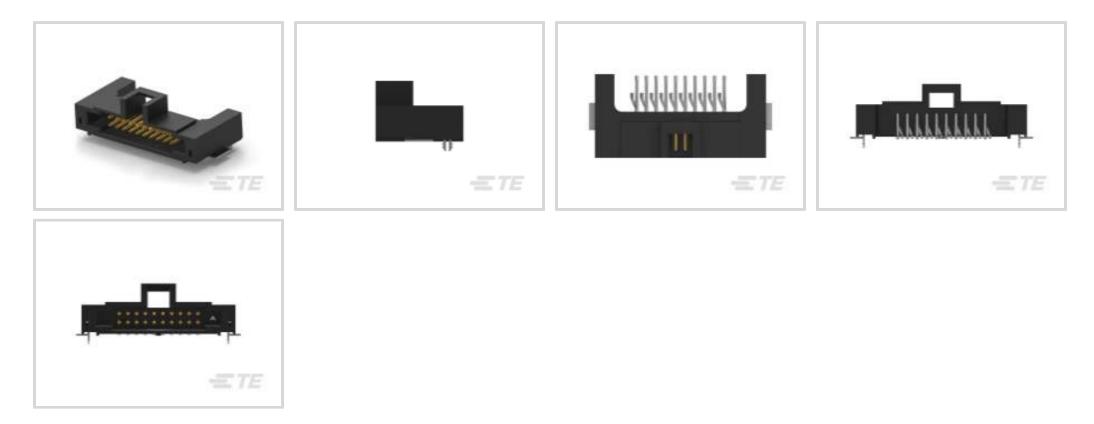


AMPMODU | AMPMODU 50/50 Grid

TE Internal #: 104895-2 PCB Mount Header, Right Angle, Board-to-Board, 20 Position, 1.27 mm [.05 in] Centerline, Fully Shrouded, Gold, Surface Mount, AMPMODU 50/50 Grid

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Right Angle

Connector System: Board-to-Board

Number of Positions: 20

Number of Rows: 2

Features

connectivity

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Right Angle
Number of Positions	20
Number of Rows	2
Electrical Characteristics	
Operating Voltage	30 VAC
Body Features	
Connector Profile	Standard

PCB Mount Header, Right Angle, Board-to-Board, 20 Position, 1.27 mm [.05 in] Centerline, Fully Shrouded, Gold, Surface Mount, AMPMODU 50/50 Grid



Primary Product Color

Black

Contact Features

	150 µin	
PCB Contact Termination Area Plating Material Finish	Matte	
Contact Shape & Form	Square	
Contact Mating Area Plating Material Finish	Bright	
Contact Underplating Material	Nickel	
PCB Contact Termination Area Plating Material	Tin-Lead	
Contact Base Material	Brass	
Contact Mating Area Plating Material	Gold	
Contact Type	Pin	
Contact Current Rating (Max)	.5 A	
Termination Features		
Termination Method to Printed Circuit Board	Surface Mount	
Mechanical Attachment		
Mating Retention	With	
Panel Mount Feature	Without	
PCB Mount Retention Type	Hold-Down Post	
Mating Alignment	With	
Mating Alignment Type	Latched	
PCB Mount Retention	With	
PCB Mount Alignment	With	
Connector Mounting Type	Board Mount	
Housing Features		
Centerline (Pitch)	1.27 mm[.05 in]	
Housing Material	LCP (Liquid Crystal Polymer)	
Dimensions		
Row-to-Row Spacing	1.27 mm[.05 in]	
Usage Conditions		
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]	
Operation/Application		
Solder Process Feature	Board Standoff	
II+1 800 522 6752	08/11	1/2023 09:

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PCB Mount Header, Right Angle, Board-to-Board, 20 Position, 1.27 mm [.05 in] Centerline, Fully Shrouded, Gold, Surface Mount, AMPMODU 50/50 Grid



Circuit Application	Power & Signal
ndustry Standards	
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	23
Packaging Type	Box, Tube
·	
or compliance documentation, visit the product page on TE.com>	Not Compliant
	Not Compliant Compliant with Exemptions
	Not CompliantCompliant with ExemptionsRestricted Materials Above Threshold

Halogen Content

Solder Process Capability

Alticle Sale Usage Statements.

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Header, Right Angle, Board-to-Board, 20 Position, 1.27 mm [.05 in] Centerline, Fully Shrouded, Gold, Surface Mount, AMPMODU 50/50 Grid

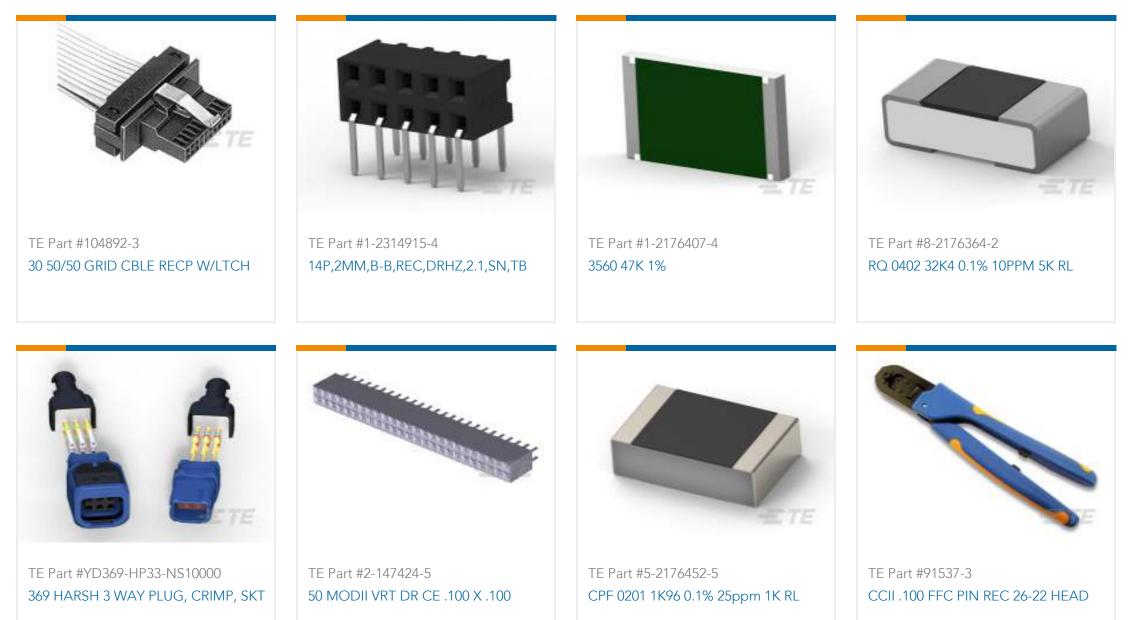




Also in the Series AMPMODU 50/50 Grid



Customers Also Bought





PCB Mount Header, Right Angle, Board-to-Board, 20 Position, 1.27 mm [.05 in] Centerline, Fully Shrouded, Gold, Surface Mount, AMPMODU 50/50 Grid



Documents

CAD Files 3D PDF

English

Customer View Model

ENG_CVM_104895-2_H.2d_dxf.zip

English

Customer View Model

ENG_CVM_104895-2_H.3d_igs.zip

English

Customer View Model

ENG_CVM_104895-2_H.3d_stp.zip

English

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Product Specifications

Application Specification

English

Product Environmental Compliance

TE Material Declaration

English

Agency Approvals UL Report

English